

MECHANICAL DESIGN OPTIMIZATION OF AN RFQ (PARTICLE) ACCELERATOR PROTOTYPE MADE BY ADDITIVE MANUFACTURING

3rd CERN Baltic Conference

G.Pikurs

Supervised by:

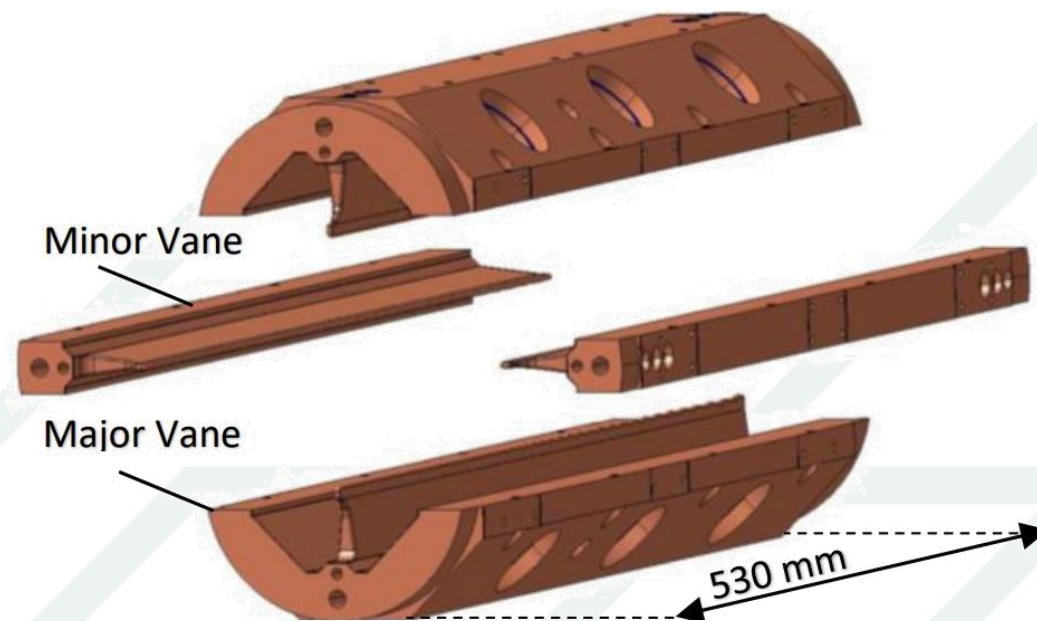
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11/10/2023

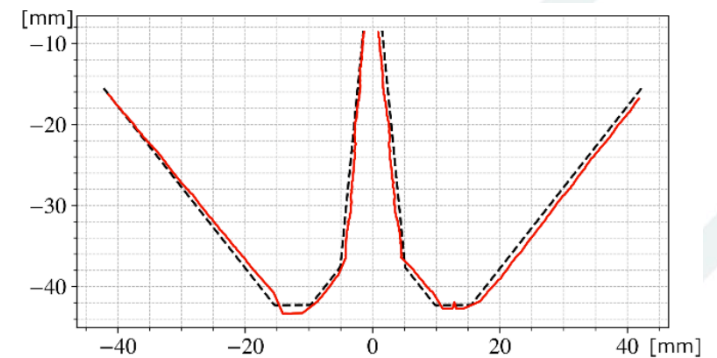
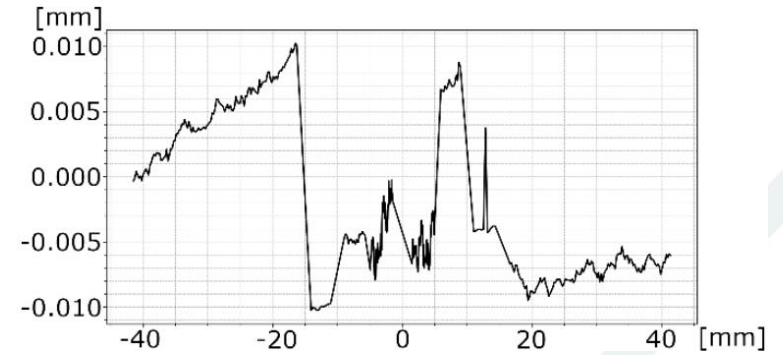
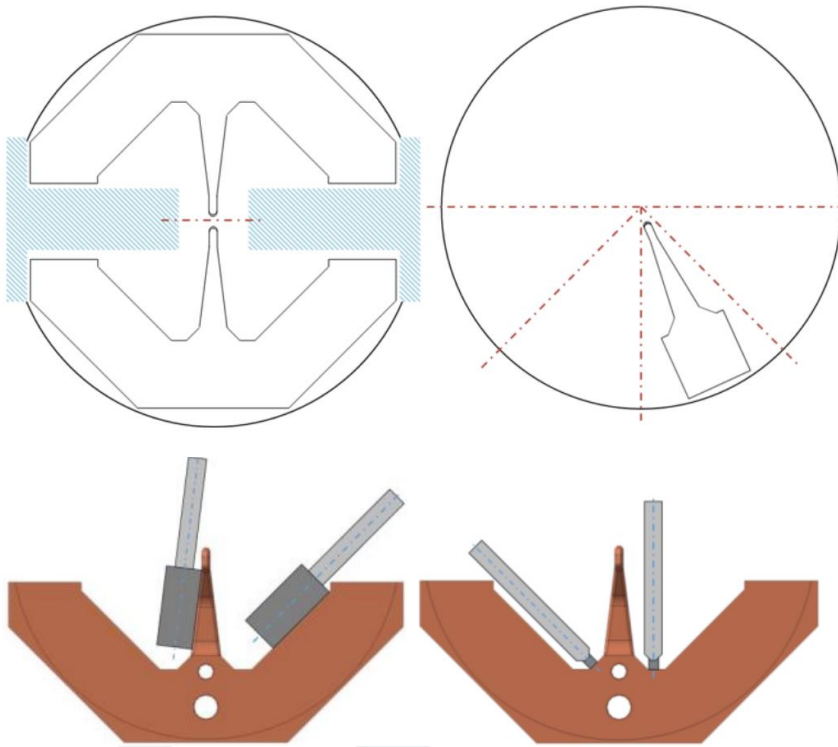
Objective of research

The aim is to develop a technology of RFQ manufacturing for AM-based design to improve overall performance and cost efficiency with respect to conventional technology.



K.Scibor et.al. PIXE-RFQ modulation and cavity machining. EUSPEN20

Conventional machining approach



K. Scibor, S.Mathot, et.al. PIXE-RFQ modulation and cavity machining. CERN EN-MME

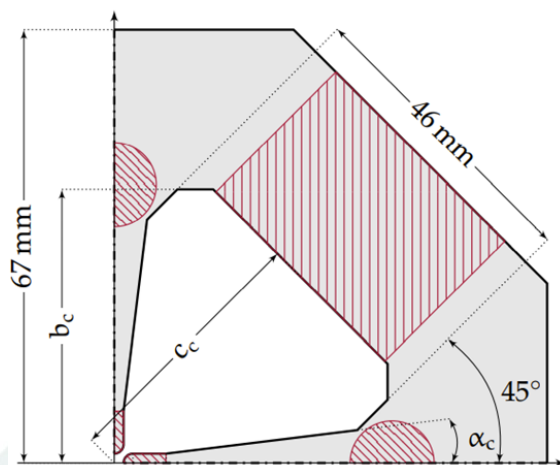
Manufacturing time for PIXE ~16months

Includes several machining, stress relief, metrology and brazing processes,
in total more than 52 manufacturing steps

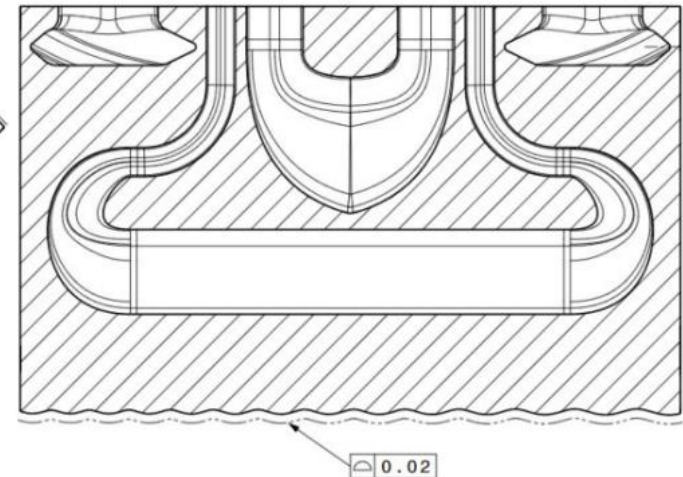
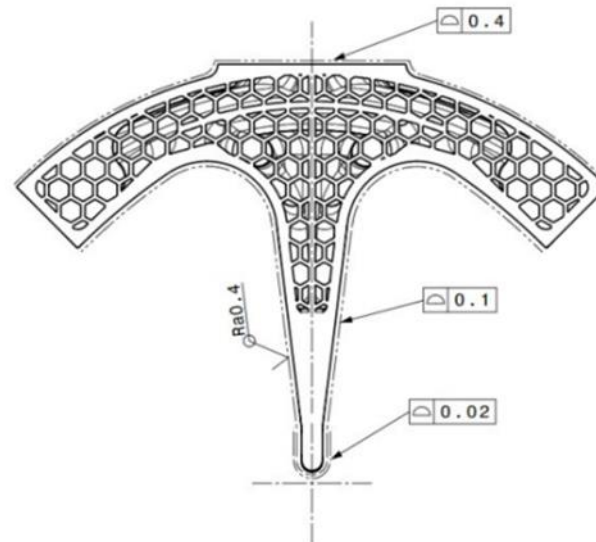
Targets set for AM RFQ

| Challenge | Target |
|---------------------------------|---|
| Geometrical accuracy | 20 μm on vane tip, 100 μm elsewhere |
| Surface roughness | $R_a=0.4\mu\text{m}$ for all inner surfaces |
| Cavity Quality factor | $>90\%$ Q_0 |
| Cooling improvement | $\Delta L < 2\mu\text{m}$ |
| Limit pressure* | 10^{-7} mbar |
| Electrical conductivity* | 95% of pure copper IACS |
| Peak electric field on surface* | $\sim 40\text{MV/m}$ |

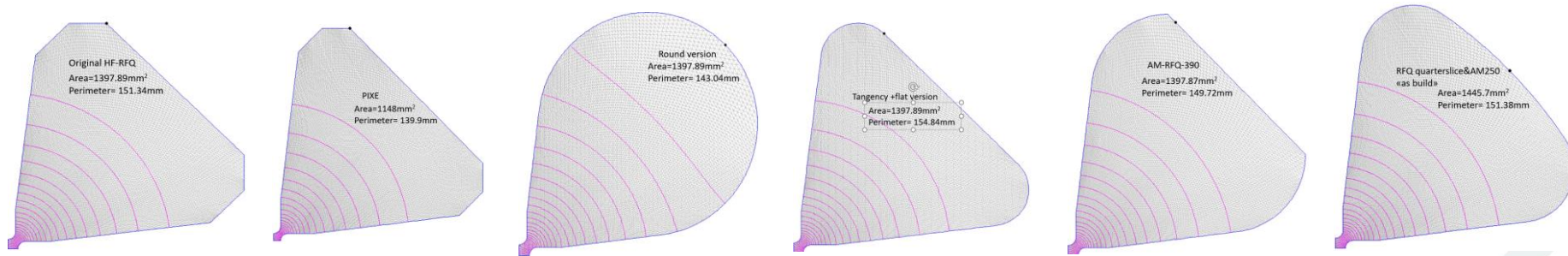
* - within scope of PhD thesis



[H.Pommerenke 2020]



RFQ cavity 2D design study



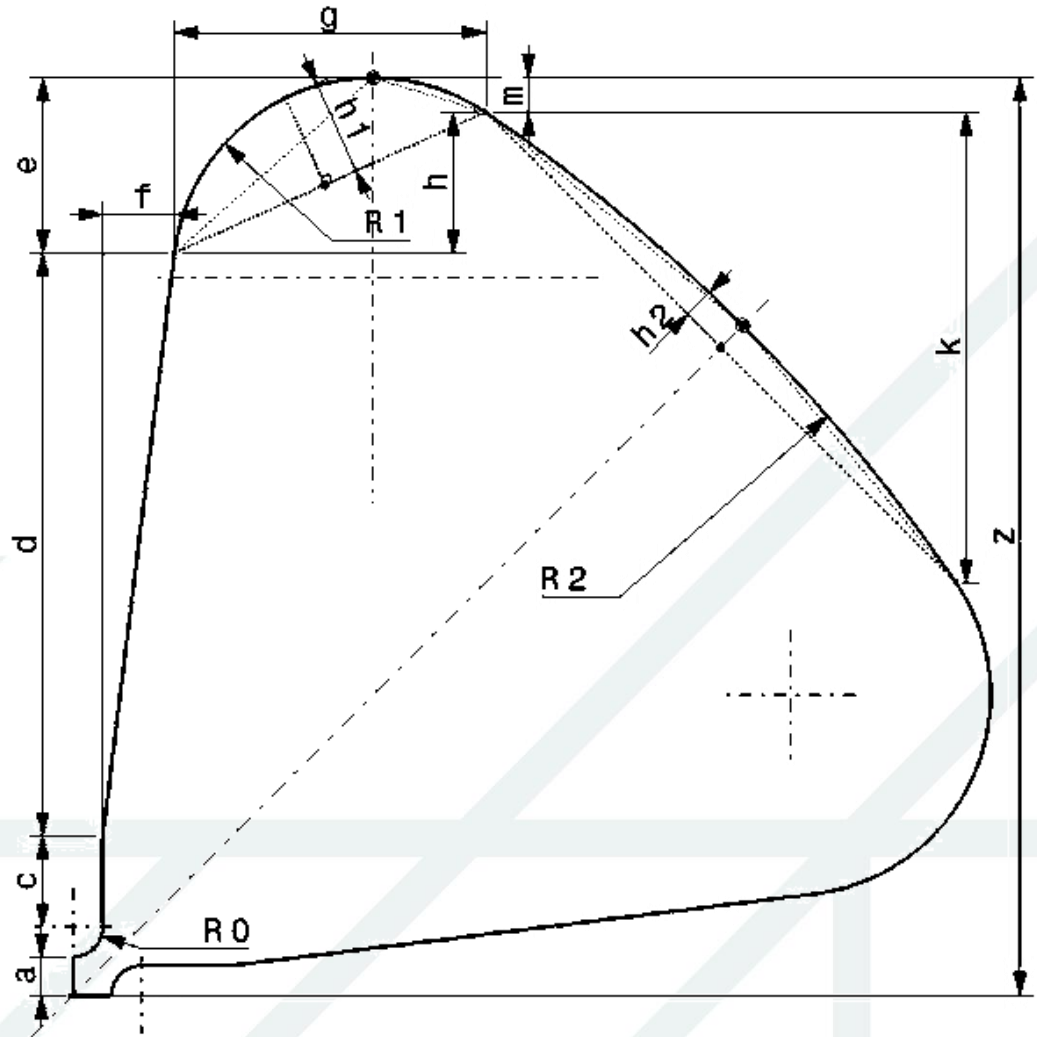
| Design name | Peri- meter, mm | Area, mm ² | Area/ Peri- meter | R. Fre- quency, MHz | Q _{0,2D} value | Tip R, mm | Aper- ture R, mm | Shunt im- pendan- ce, MΩ/m | Stored energy x10 ⁻⁵ J/cm |
|-------------------|-----------------------|--------------------------|-------------------------|---------------------------|----------------------------|-----------------|------------------------|----------------------------------|--|
| HF-RFQ | 151.34 | 1397.89 | 9.237 | 716.56 | 8028.51 | 1.504 | 1.935 | 6303.89 | 6.8775 |
| PIXE | 139.9 | 1148 | 8.206 | 728.97 | 7156.49 | 1.439 | 1.439 | 6286.239 | 6.87484 |
| Carbon | 142.15 | 1202 | 8.456 | 709.78 | 7273.45 | 1.411 | 1.411 | 6620.685 | 6.87443 |
| RoundDesign | 143.04 | 1397.89 | 9.773 | 714.75 | 8608.20 | 1504 | 1.935 | 6737.561 | 6.91407 |
| Tangency+F | 154.84 | 1397.89 | 9.028 | 716.59 | 7811.74 | 1.504 | 1.935 | 6133.634 | 6.90091 |
| AM390 | 149.72 | 1397.87 | 9.337 | 716.44 | 8138.77 | 1.504 | 1.935 | 6388.894 | 7.55072 |
| AM 1/4 RFQ | 151.38 | 1445.7 | 9.550 | 703.25 | 8254.51 | 1.504 | 1.935 | 6578.903 | 6.90091 |
| AM250-200 μm | 152.1 | 1475.2 | 9.699 | 736.70 | 8569.27 | 1.304 | 2.135 | 6574.460 | 4.36554 |

Alternative 2D quality factor model

$$Q_{0,2D} = \frac{S}{L} \kappa$$

The quality factor Q is a ratio of the energy stored in the cavity to the energy dissipated in the walls per RF cycle.

$$Q_0 = \frac{\omega_0 W_0}{P_0}$$



Q-factor calculation

$$S = z^2 - (a + R_0 + c + d + e)^2 - \frac{1}{2}\pi R_0^2 - 2R_0c - 2R_0d - df - 2R_0ef - 2(eg - (gh + R_1^2 \cos^{-1}(\frac{R_1 - h_1}{R_1}))) - (R_1 - h_1)\sqrt{2R_1h_1 - h_1^2} - 2(k + \frac{l}{2})m - (k^2 - (\frac{1}{2}k^2 + R_2^2 \cos^{-1}(\frac{R_2 - h_2}{R_2}))) - (R_2 - h_2)\sqrt{2R_2h_2 - h_2^2}$$

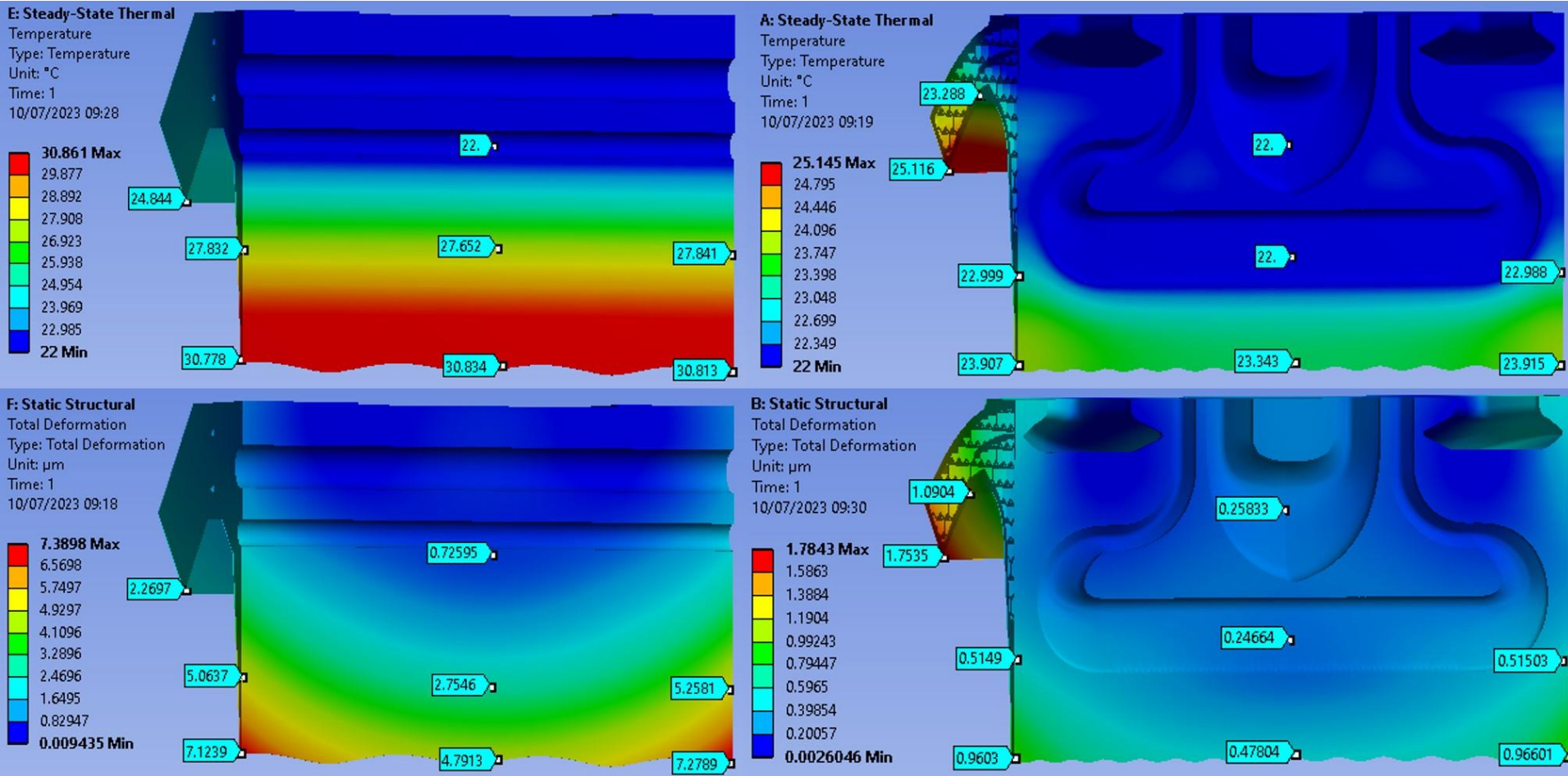
$$L = a + \frac{\pi R_0}{2} + c + \sqrt{d^2 + f^2} + 2R_1 \cos^{-1}(\frac{R_1 - h_1}{R_1}) + R_2 \cos^{-1}(\frac{R_2 - h_2}{R_2})$$

κ - Q factor coefficient adopted for 750MHz RFQ design line $\kappa=890.9$

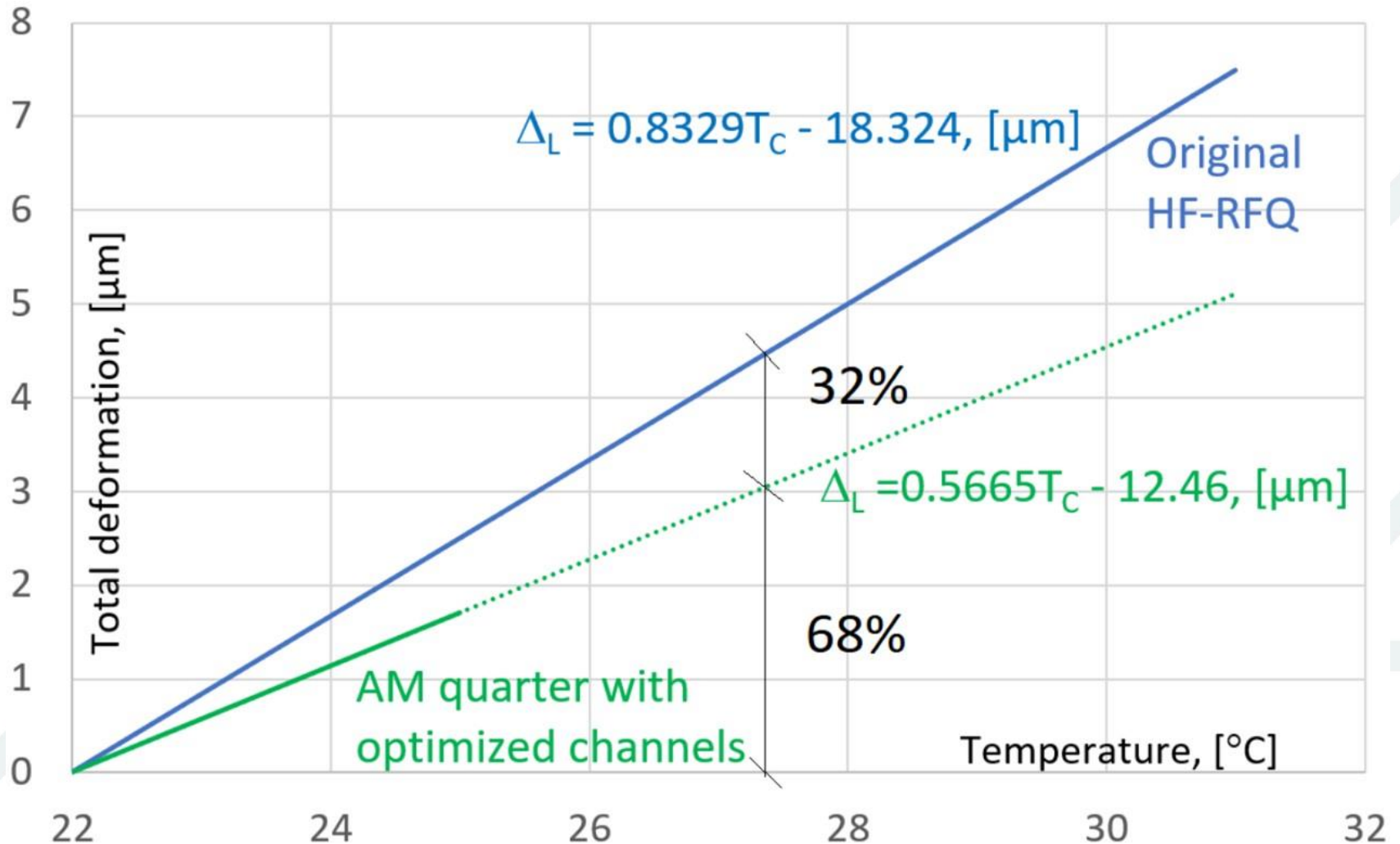
Alternative math model results

| Design name | Mathmodel | | | | SUPERFISH | | | | |
|-------------------|---------------|-----------------------|----------------|-------------------------|-------------------|-------------------------|-----------|-----------------|---------------------|
| | Perimeter, mm | Area, mm ² | Area/Perimeter | Q _{0,2D} value | R. Frequency, MHz | Q _{0,2D} value | Tip R, mm | Aperature R, mm | Q value deviation % |
| HF-RFQ | 151.34 | 1397.89 | 9.237 | 8044.26 | 716.56 | 8028.51 | 1.504 | 1.935 | 0.19 |
| PIXE | 139.9 | 1148 | 8.206 | 7146.45 | 728.97 | 7156.49 | 1.439 | 1.439 | -0.14 |
| Carbon | 142.15 | 1202 | 8.456 | 7364.17 | 709.78 | 7273.45 | 1.411 | 1.411 | 1.25 |
| RoundDesign | 143.04 | 1397.89 | 9.773 | 8511.03 | 714.75 | 8608.20 | 1504 | 1.935 | -1.13 |
| Tangency+F | 154.84 | 1397.89 | 9.028 | 7862.43 | 716.59 | 7811.74 | 1.504 | 1.935 | 0.65 |
| AM390 | 149.72 | 1397.87 | 9.337 | 8131.18 | 716.44 | 8138.77 | 1.504 | 1.935 | -0.09 |
| AM 1/4 RFQ | 151.38 | 1445.7 | 9.550 | 8317.19 | 703.25 | 8254.51 | 1.504 | 1.935 | 0.76 |
| AM250-200 μm | 152.1 | 1475.2 | 9.699 | 8446.73 | 736.70 | 8569.27 | 1.304 | 2.135 | -1.43 |

Temperature distribution and Max total deformation for design versions(SteadyState Thermal +Static Structural)

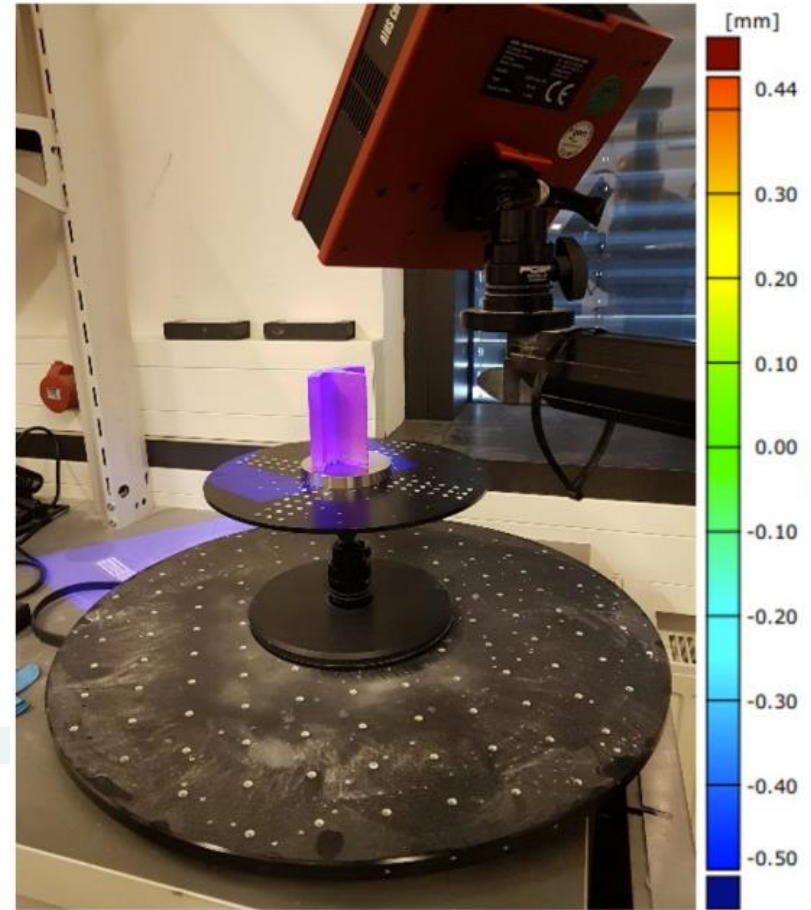
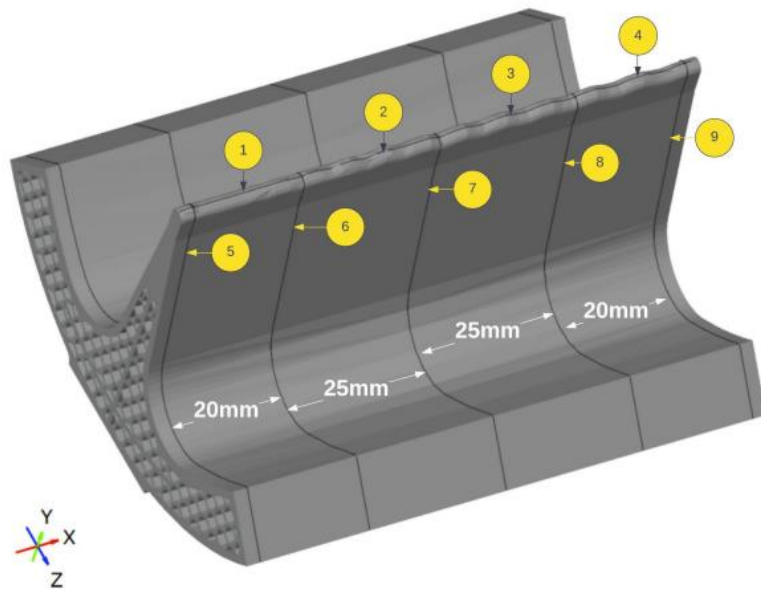


Max total deformation as function from temperature



Metrological inspections

- CMM
- Optical



Postprocessing

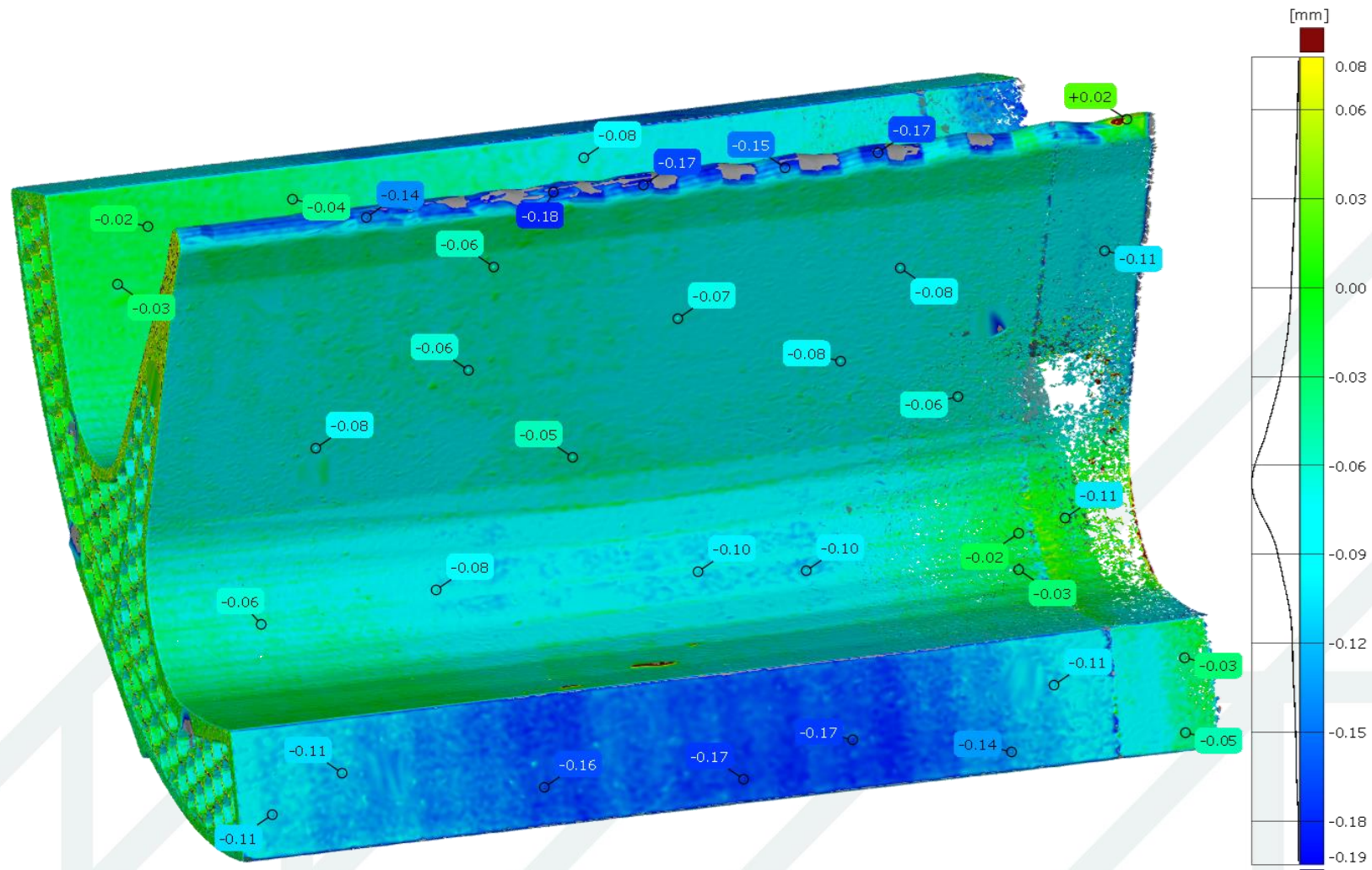
- Mass finishing at Rosler Italiana
- MMP technology[®] by BINC industries

-Initial surface roughness for «as built» part average profile roughness value Ra15

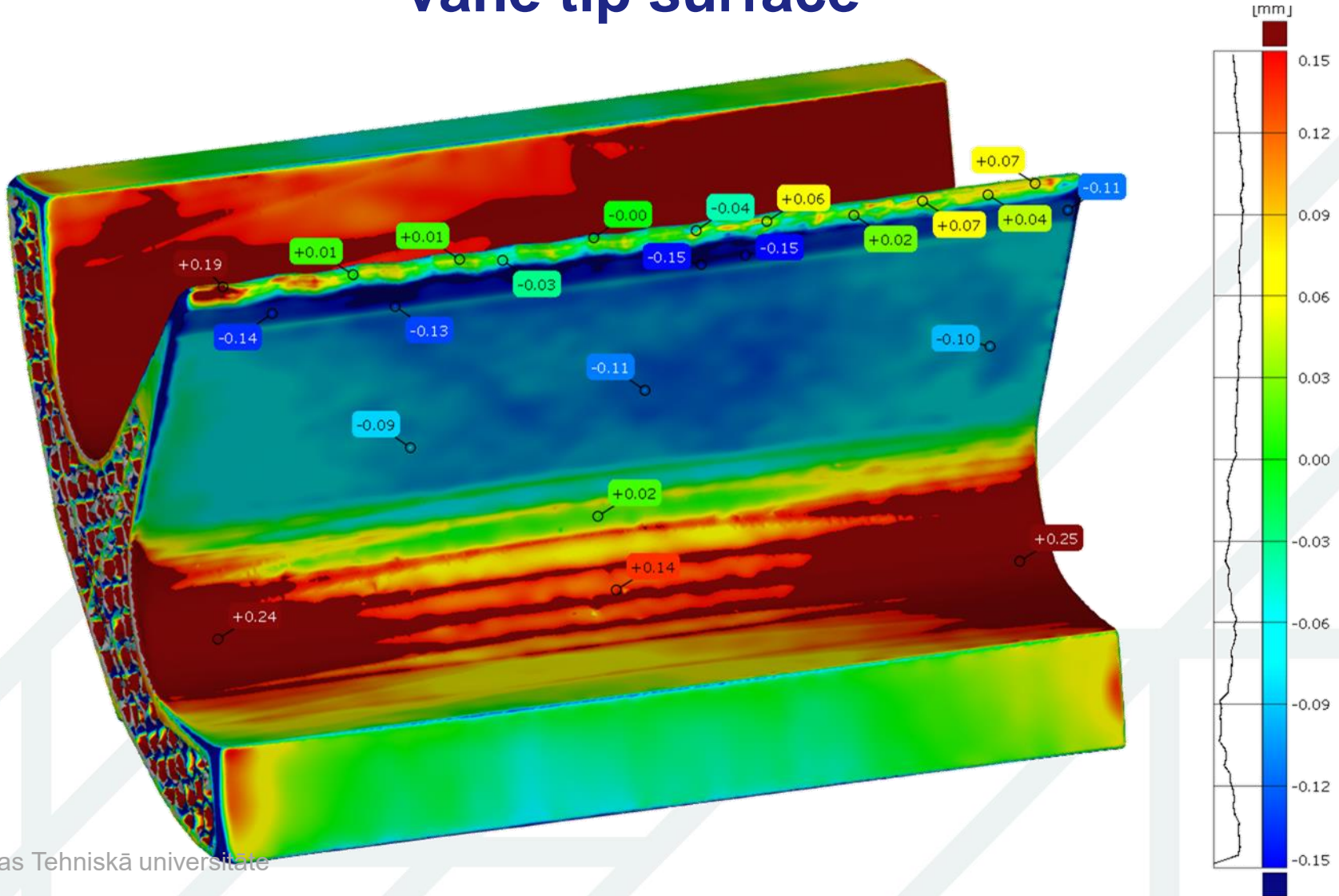
-Average surface profile roughness after treatment Ra0.2



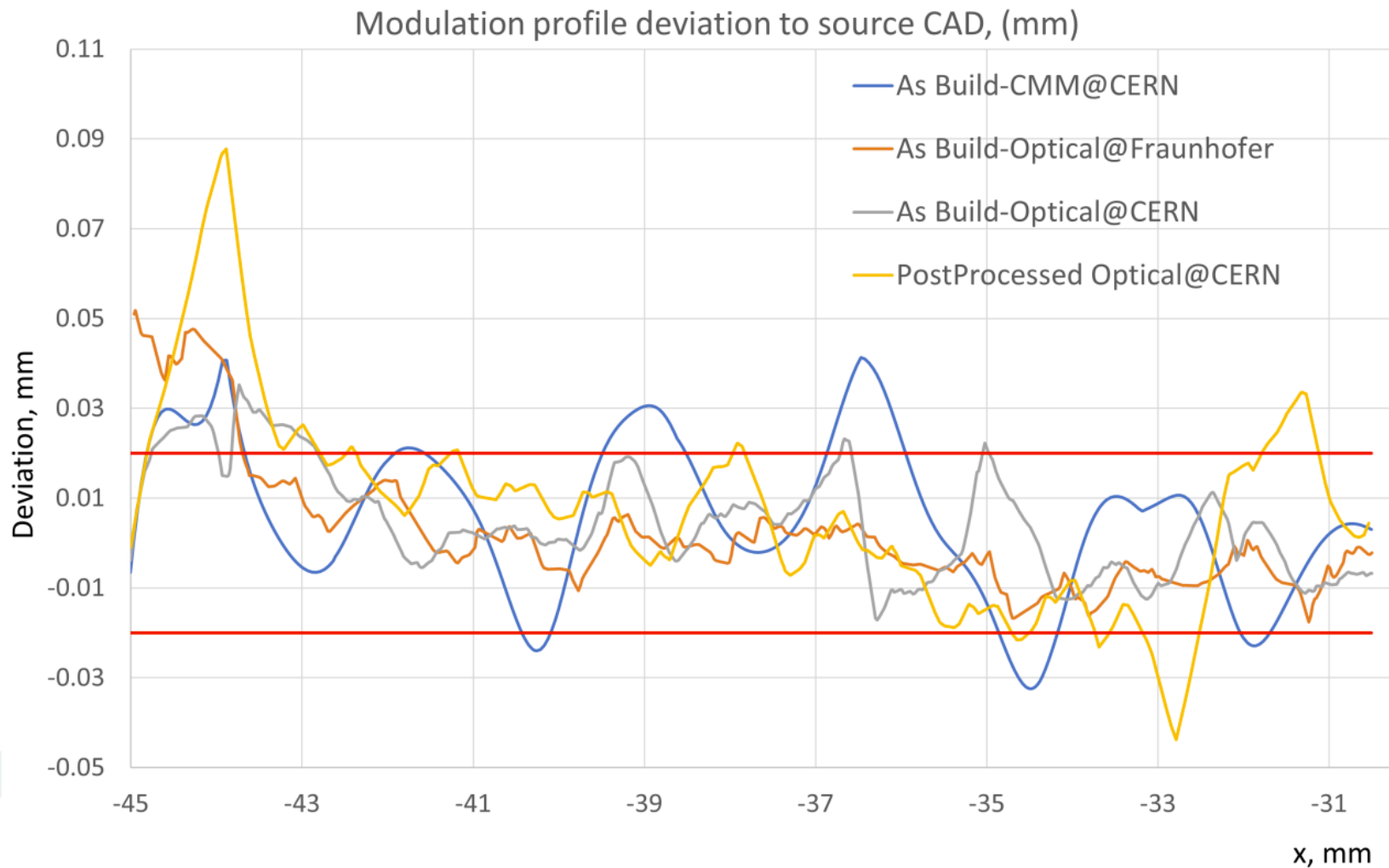
Pointcloud and CAD global «best fit» alignment for «as build» part



Postprocessed by MMP technology AM-RFQ pointcloud vs CAD model local «best fit» on vane tip surface



Vane tip modulation deviation



AM vs conventional technology

| Parameter | Conventional | AM | Reduction, % |
|---|----------------------|---------------------|--------------|
| Manufacturing time, months | 16* | 4** | 75 |
| Material waste, % | 41.2 | 2.5 | 39.7 |
| Number of manufacturing substeps | 52*** | 15 | 71 |
| Weight****, kg/m | 175 | 55 | 68.6 |
| Geometric accuracy | excellent | acceptable | -10 |
| Cooling performance by Δ_L , μm | $0.8329T_C - 18.324$ | $0.5665T_C - 12.46$ | 32 |
| Quality factor Q_{2D} | 8028.51 | 8254.51 | 2.6 |

* - value from ELISA project for PIXE RFQ;

** - estimated values based on IFAST WP10 activities and assumptions;

*** - PIXE technology;

**** - weight calculation for full RFQ sector/brazed unit

Conclusions

- AM is a highly progressing technology and it is well suited for the complex geometries of accelerator components.
- AM allows improvement of the shape and routing of the RFQ cooling channels, improving heat removal and thermal distortions significantly.
- Surface postprocessing for AM parts are critical and compensation methods must be applied.

Thank you for attention!